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# N-Channel PowerTrench<sup>®</sup> MOSFET 60 V, 22 A, 8.2 m $\Omega$

# Features

- $\blacksquare$  Max  $r_{DS(on)}$  = 8.2 m $\Omega$  at  $~V_{GS}$  = 10 V,  $I_{D}$  = 13.5 A
- $\blacksquare$  Max  $r_{DS(on)}$  = 11.7 m $\Omega$  at V\_{GS} = 4.5 V, I\_D = 11.5 A
- Advanced package and silicon combination for low r<sub>DS(on)</sub> and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

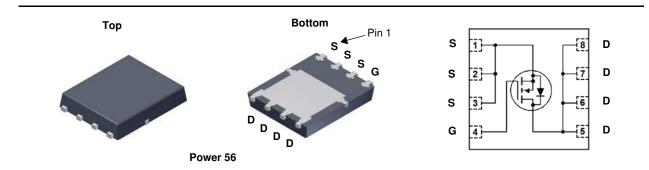


# **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed and body diode reverse recovery performance.

# Applications

- Primary Switch in isolated DC-DC
- Synchronous Rectifier
- Load Switch



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	ol Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			60	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		22		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	13.5	Α	
	-Pulsed			60		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	91	mJ	
D	Power Dissipation	T <sub>C</sub> = 25 °C		69		
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/ VV

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86520L	FDMS86520L	Power 56	13 "	12 mm	3000 units

	Max	Units	
		V	
		mV/°C	
	1	μA	
	±100	nA	
	3	V	
		mV/°C	
	8.2		
	11.7	mΩ	
	11.8		
		S	
I	4615	pF	
	835	pF	
	45	pF	

Ω

### Switching Characteristics

**Dynamic Characteristics** 

Symbol

BV<sub>DSS</sub>

 $\Delta BV_{DSS}$ 

 $\Delta T_{J}$ 

IDSS

I<sub>GSS</sub>

V<sub>GS(th)</sub>

 $\Delta T_{J}$ 

r<sub>DS(on)</sub>

9<sub>FS</sub>

Ciss

 $C_{\text{oss}}$ 

 $C_{rss}$ 

 $R_g$ 

 $\Delta V_{GS(th)}$ 

**Off Characteristics** 

**On Characteristics** 

Coefficient

Electrical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

Breakdown Voltage Temperature

Zero Gate Voltage Drain Current

Gate to Source Leakage Current

Gate to Source Threshold Voltage

Gate to Source Threshold Voltage

Static Drain to Source On Resistance

Temperature Coefficient

Forward Transconductance

**Reverse Transfer Capacitance** 

Input Capacitance

Gate Resistance

**Output Capacitance** 

t <sub>d(on)</sub>	Turn-On Delay Time		15	27	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 13.5 A,	5.6	11	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	32	52	ns
t <sub>f</sub>	Fall Time		3.4	10	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	45	63	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 30 V,$	21	30	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 13.5 A	9.5		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		4.7		nC

**Test Conditions** 

 $I_D = 250 \ \mu$ A, referenced to 25 °C

 $I_D = 250 \ \mu A$ , referenced to 25 °C

 $I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V$ 

 $V_{DS} = 48 V, V_{GS} = 0 V$ 

 $V_{GS} = \pm 20 V, V_{DS} = 0 V$ 

 $V_{GS} = V_{DS}, I_D = 250 \ \mu A$ 

 $V_{GS} = 10 V, I_D = 13.5 A$ 

 $V_{GS} = 4.5 V, I_{D} = 11.5 A$ 

 $V_{GS} = 10 V, I_D = 13.5 A,$ 

V<sub>DS</sub> = 5 V, I<sub>D</sub> = 13.5 A

 $V_{DS} = 30 V, V_{GS} = 0 V,$ 

T<sub>.1</sub> = 125 °C

f = 1 MHz

Min

60

1

Тур

29

1.8

-7

6.7

9.1

9.6

51

3470

625

25

0.6

#### **Drain-Source Diode Characteristics**

V <sub>SD</sub>	Source-Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2.1 A (Note 2)	0.72	1.2	v
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 13.5 A (Note 2)	0.83	1.3	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 13.5 A, di/dt = 100 A/μs	37	60	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{\rm F} = 13.5 \text{ A},  \text{di/dt} = 100 \text{ A/}\mu\text{s}$	21	34	nC
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 13.5 A, di/dt = 300 A/μs	30	48	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 13.5 \text{ A, di/dt} = 300 \text{ A/}\mu\text{s}$	37	59	nC

Notes:

1. R<sub>0,A</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



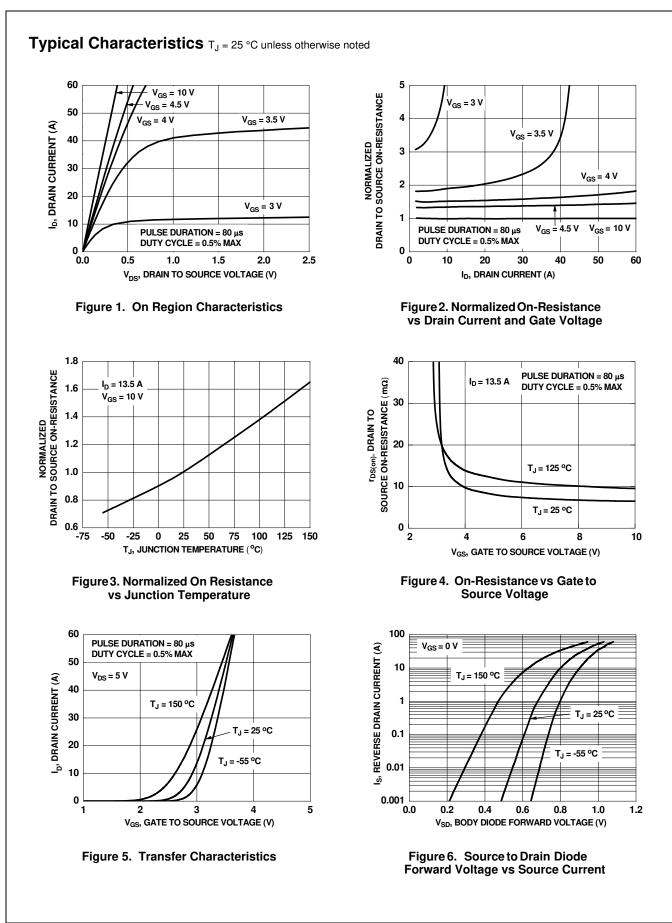
a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

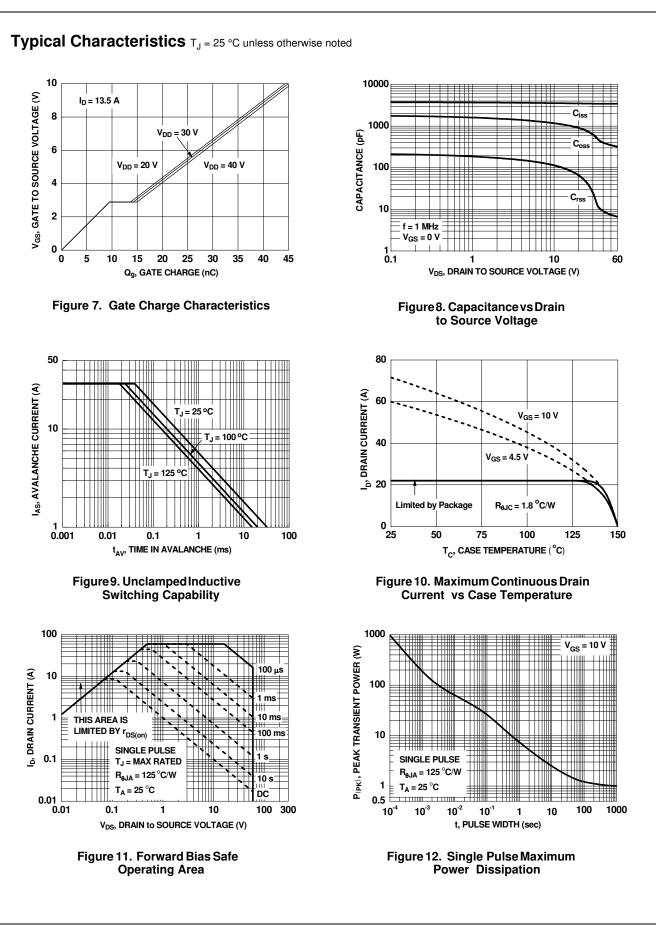
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

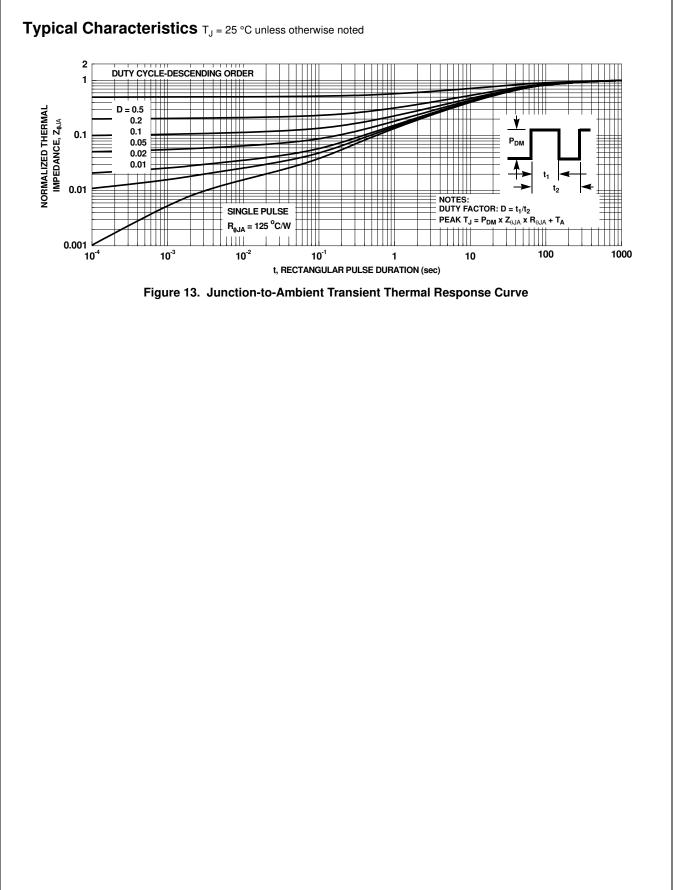


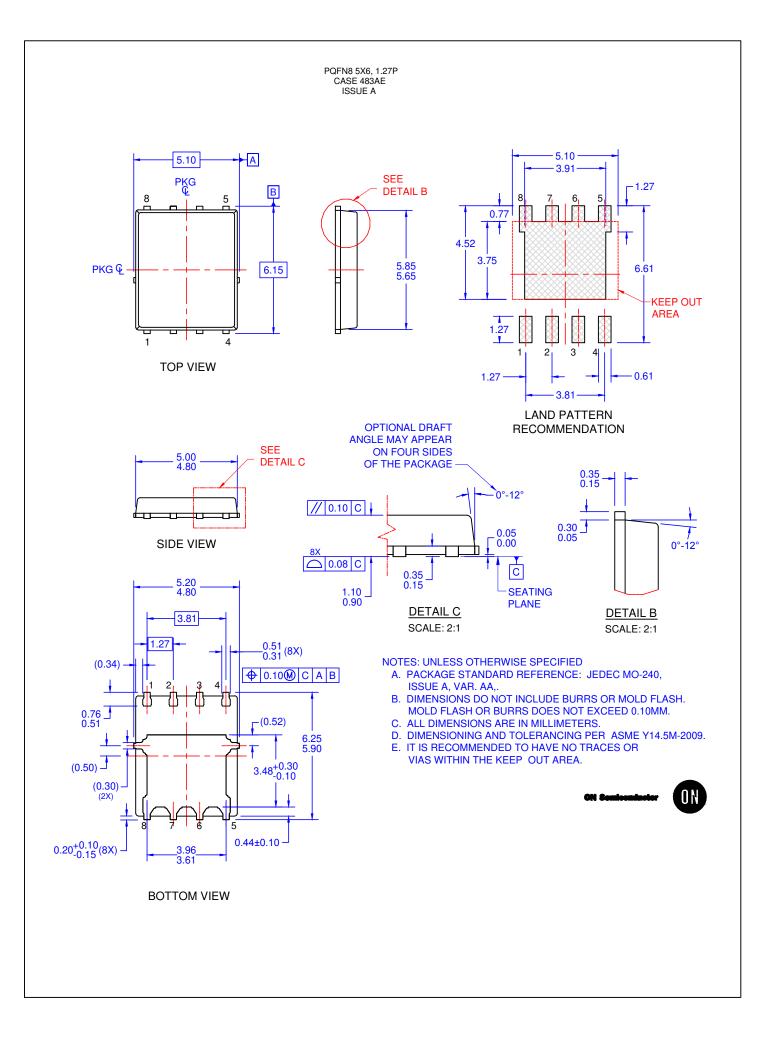
2. Pulse Test: Pulse Width < 300 µs, Duty cycle < 2.0%.

3. Starting  $T_J = 25$  °C, L = 1 mH,  $I_{AS} = 13.5$  A,  $V_{DD} = 54$  V,  $V_{GS} = 10$  V. 100% test at L = 0.1 mH,  $I_{AS} = 29$  A.









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